

1.6x1.6mm FULL-COLOR SURFACE MOUNT **LED**



ATTENTION

OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES**

Part Number: APTF1616SEKJ3ZGKQBKC

Hyper Red Green

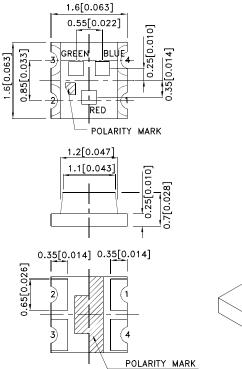
Features

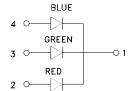
- 1.6mmX1.6mm SMT LED, 0.7mm thickness.
- Low power consumption.
- Can produce any color in visible spectrum, including white light.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

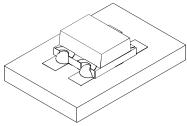
Descriptions

- The Hyper Red device is based on light emitting diode chip made from AlGaInP.
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.
- The Blue source color devices are made with InGaN Light Emitting Diode.
- Electrostatic discharge and power surge could damage
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

Package Dimensions







- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.2(0.008") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		-	Min.	Тур.	201/2
APTF1616SEKJ3ZGKQBKC	Hyper Red (AlGaInP)		200	350	120°
	Green (InGaN)	Water Clear	200	300	
	Blue (InGaN)		40	70	

Notes:

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.
- 3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Green Blue	640 515 460		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red Green Blue	625 525 465		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Green Blue	20 35 25		nm	IF=20mA
С	Capacitance	Hyper Red Green Blue	27 45 100		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red Green Blue	2.2 3.3 3.3	2.8 4.1 4	V	IF=20mA
lR	Reverse Current	Hyper Red Green Blue		10 50 50	uA	V _R =5V

- 1. Wavelength: +/-1nm.

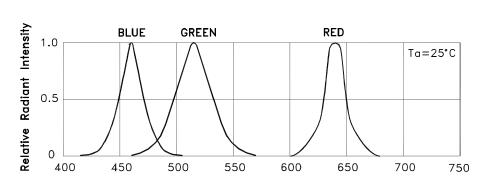
- Wavelength value is traceable to the CIE127-2007 compliant national standards.
 Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

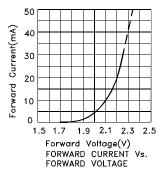
Parameter	Hyper Red	Green	Blue	Units		
Power dissipation	84	102.5	120	mW		
DC Forward Current	30	25	30	mA		
Peak Forward Current [1]	150	150	150	mA		
Reverse Voltage	5 V					
Operating Temperature	-40°C To +85°C					
Storage Temperature	-40°C To +85°C					

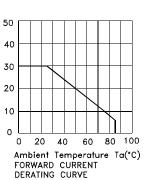
Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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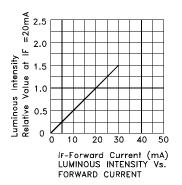


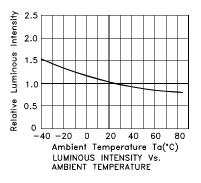
APTF1616SEKJ3ZGKQBKC Hyper Red

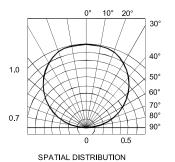




Forward Current(mA)



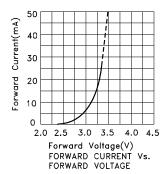


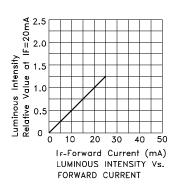


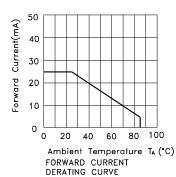
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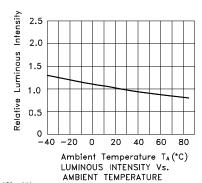
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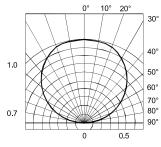
Green









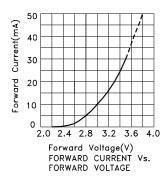


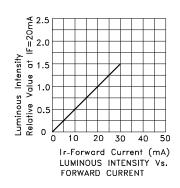
SPATIAL DISTRIBUTION

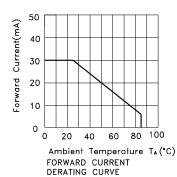
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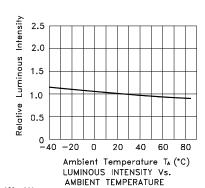
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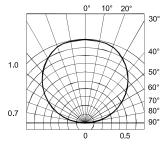
Blue











SPATIAL DISTRIBUTION

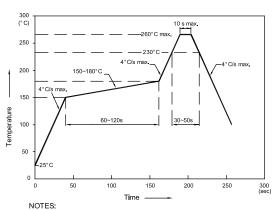
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



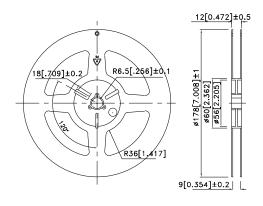
- 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature
- to high temperature.
 3.Number of reflow process shall be 2 times or less.

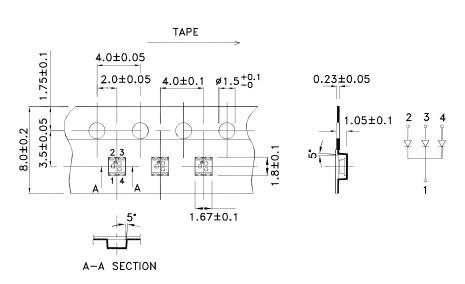
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

0.9

Tape Dimensions (Units : mm)

Reel Dimension



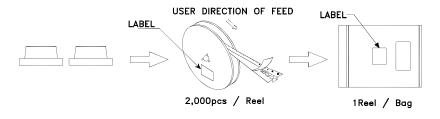


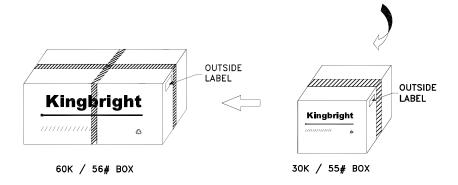
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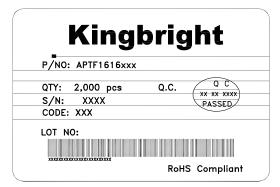


PACKING & LABEL SPECIFICATIONS

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